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Powered by Intel.



High-Performance, Reliable, and Flexible

Join us at our booth for in-depth technical and application-focused sessions on our standard COMExpress solutions. Our experts will provide insights into design optimization, performance scalability, and real-world implementation scenarios across various industries. Visitors will have the opportunity to explore how our COMExpress modules based on Intel Atom® Processor X Series and 13th/14th Gen Intel® Core™ processors enable high-performance, reliable, and flexible embedded systems — perfectly suited for demanding applications. Discover the latest advancements and learn how our partnership with Intel enhances system efficiency and innovation.

Partner Link:

[COMe 10M-ASL Solution](#)

[COMe 6C-RPL Solution](#)

Meeting Request Link:

events@engicam.com

Partner Name

Engicam Srl

Booth Location

Hall C – Booth 2063

Solution Names

- **COMe 6C-RPL**
The new Engicam COMe module for IoT applications
- **COMe 10M-ASL**
Standard COM Express® Mini type 10 for edge AI



embeddedworld

Exhibition & Conference

North America